# **<b>&TDK** Multilayer Ceramic Chip Capacitors

#### C0603X5R1E224M030BC



#### TDK item description C0603X5R1E224MT\*\*\*\*

tion C0603X5R1E224MT****	<u>~~</u> µ
Commercial Grade	
General General (Up to 50V)	
C0603 [EIA 0201]	6
Production (Not Recommended for New Design)	Dimensions in m
	Commercial Grade General General C0603 [EIA 0201]

Size	
Length(L)	0.60mm ±0.05mm
Width(W)	0.30mm ±0.05mm
Thickness(T)	0.30mm ±0.05mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.20mm Min.
Recommended Land Pattern (PA)	0.25mm to 0.35mm
Recommended Land Pattern (PB)	0.20mm to 0.30mm
Recommended Land Pattern (PC)	0.25mm to 0.35mm

Electrical Characteristics		
Capacitance	220nF ±20%	
Rated Voltage	25VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	454ΜΩ	

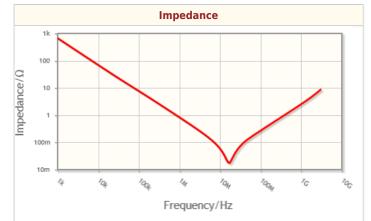
Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	15000pcs

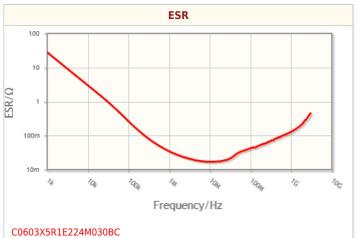
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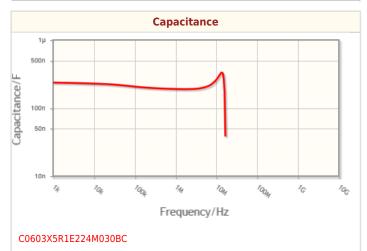


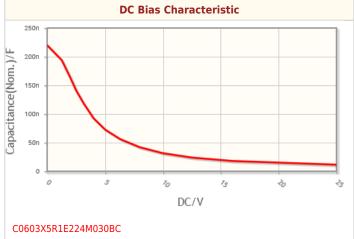


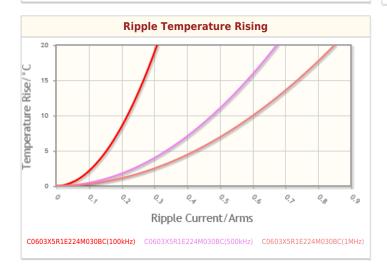


## Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

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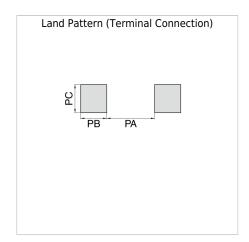
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# Associated Images



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